

1 **Fabrication of a novel and green thin-film composite**
2 **membrane containing nanovoids for water purification**

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13 **Abstract**

14 Thin film nanocomposite (TFN) membranes, which incorporate nanomaterials in a
15 crosslinked polyamide matrix, often show enhanced separation properties thanks to
16 the additional pores or channels offered by these materials. In this study, we
17 deliberately created nanovoids in the dense polyamide rejection layer by acid-etching
18 copper nanoparticles (CuNPs) contained in a TFN membrane. Systematic membrane
19 characterization confirmed the complete removal of CuNPs using 1% HNO₃, which
20 formed nanovoids of approximately 10 nm in size. The water flux of the etched
21 membrane TFC-Cu50X was nearly quadrupled compared to that of the CuNPs loaded
22 membrane TFC-Cu50. This significantly improved water flux can be ascribed to the
23 enhanced water transport through these nano-sized voids. The nanovoids-enhanced
24 approach provides new possibilities for synthesizing high performance membranes.

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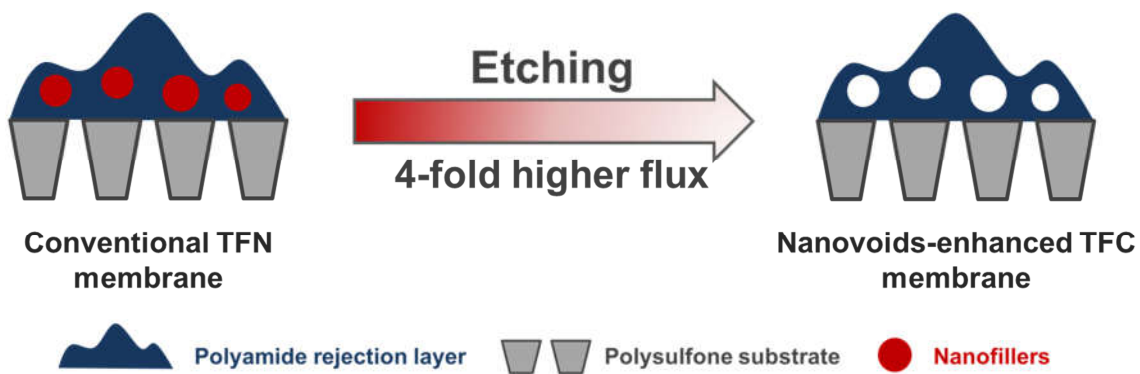
27 **Keywords:** Thin-film composite membrane; polyamide rejection layer; copper
28 nanoparticles; nanovoids; water permeability

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32 **Graphical abstract**



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35 **1. Introduction**

36 Thin-film nanocomposite (TFN) membranes, which incorporate nanomaterials in a
37 salt-rejecting polyamide (PA) layer, have attracted tremendous attention in the past
38 decade [1-3]. Compared to thin-film composite (TFC) membranes, TFN can
39 dramatically improve membrane water permeability (e.g., up to 200% enhancement),
40 while maintaining similar salt rejection [1]. Notably, the embedded nanomaterials
41 with micro or mesopores, such as zeolite [4, 5], mesoporous silica [6, 7],
42 metal-organic-framework (MOF) [8] and carbon nanotubes [9] could further enhance
43 membrane water permeability compared to their solid counterparts. The higher water
44 flux can be ascribed to the preferential water pathway in the nanovoids of these
45 porous nanomaterials [6]. Despite the enhanced membrane separation performance,
46 conventional TFN membranes still have some obstacles, such as potential leaching
47 [10] and nanomaterials toxicity [11].

48

49 The improved porosity of polyamide rejection layer can significantly improve
50 membrane separation performance [12, 13]. As an alternative approach to
51 conventional TFN, Livingston and co-workers [14] applied microporous monomers
52 for interfacial polymerization, resulting in the formation of a microporous
53 cross-linked rejection layer that showed excellent permeability and selectivity
54 compared to commercial membranes. In a more recent study [13], we reported series
55 of approaches to generate nanovoids in the polyamide rejection layer by the formation

56 of nanosized gas bubbles (e.g., by the addition of bicarbonate or ultrasound
57 application) during the interfacial polymerization. These nanovoids significantly
58 increased both membrane water permeability and salt rejection. Several studies also
59 highlighted the importance of the microporous structure of membrane rejection layer
60 [15-20].

61

62 In this study, we report a facile method to fabricate novel high performance TFC
63 membranes, where nanovoids were generated through the etching of nanoparticles
64 incorporated in the PA-PSF interface. Specifically, we first synthesized copper
65 nanoparticles (CuNPs) loaded TFN membranes, followed by their removal using an
66 HNO₃ solution to create an “arch-like” polyamide morphology. We hypothesize that
67 these nanovoids could significantly decrease the membrane hydraulic resistance, thus
68 greatly enhancing water permeability. This work provides a novel insight into the
69 fabrication of a high performance nanovoids-enhanced TFC membrane.

70

71 **2. Methods**

72 *2.1. Materials and reagents*

73 Chemicals for the preparation of membrane substrates and interfacial polymerization,
74 including polysulfone (PSF, Mw 35,000), *N,N*-dimethylformamide (DMF, anhydrous
75 99.8%), *m*-Phenylenediamine (MPD, flakes, 99%), trimesoyl chloride (TMC, 98%),
76 and hexane (HPLC grade, 97%) were all obtained from Sigma-Aldrich. Cupric
77 sulfate-anhydrous (CuSO₄, AR, Dieckmann, Hong Kong) and sodium borohydride
78 (NaBH₄, 98%, Sigma-Aldrich) were used to generate CuNPs *in situ* on polysulfone
79 substrate. Sodium chloride (NaCl) was obtained from Uni-Chem, and nitric acid
80 (HNO₃, 69%) was provided by VWR Chemicals (Dorset, U.K.).

81

82 *2.2. Synthesis of PSF and CuNPs functionalized PSF support layers*

83 The polysulfone support layer (15 wt. % in DMF) were prepared based on our
84 previous study [21]. The recipe of copper nanoparticles (CuNPs) coating is modified
85 from the literature [22]. As shown in Fig. 1, a polysulfone substrate membrane (20 ×
86 12 cm) was placed in a container. A 50 mL CuSO₄ solution was poured onto the
87 polysulfone substrate for 10 mins under continuous shaking of 50 revolutions per
88 minute (rpm) on a reciprocal shaking bath (Unitronic Reciprocal 6032011, J.P. Selecta,
89 S.A., Barcelona, Spain). The excess CuSO₄ solution was removed by a rubber roller
90 before. A 50 mL NaBH₄ solution was poured onto the CuSO₄ impregnated
91 polysulfone substrate for 5 mins under the same shaking condition to form the copper
92 nanoparticles. After that, the resulting substrate was rinsed for approximately 5 mins

93 with deionized (DI) water. Based on the concentration (0, 50, 100, 200mM) of the
94 CuSO_4 and NaBH_4 solutions, the CuNPs coated polysulfone substrates are denoted as
95 PSF, PSF-Cu50, PSF-Cu100, and PSF-Cu200, respectively.

96

97 *2.3. Synthesis of TFC and, TFC-Cu and TFC-CuX membranes*

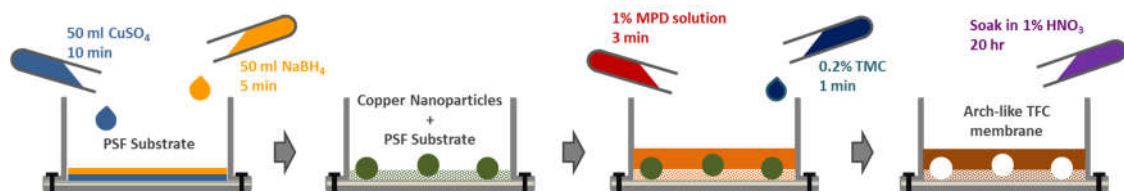
98 To prepare polyamide rejection layer on the polysulfone substrate, we performed
99 interfacial polymerization on the PSF-Cu substrates (Fig. 1). Briefly, a PSF-Cu
100 substrate was immersed in a 1.0 wt. % MPD-water solution for 3 mins. Then, the
101 excess MPD/water solution was removed by a rubber roller. A TMC-hexane solution
102 (0.2 wt. %) was then added onto the MPD impregnated substrate for 1 min to form the
103 polyamide rejection layer. The resultant membrane was immediately rinsed with
104 hexane and stored in an oven at 60°C for 10 mins. Finally, the obtained membrane
105 was stored in DI water at least overnight before use. The control TFC membrane was
106 directly synthesized on the PSF substrate without CuNPs treatment. The resultant
107 membranes are named as TFC, TFC-Cu50, TFC-Cu100 and TFC-Cu200 membranes,
108 respectively, based on their CuNPs loading conditions.

109

110 To generate nanovoids in the polyamide layer, we etched the CuNPs in the TFC-Cu
111 membranes (Fig. 1). Briefly, a TFC-Cu membrane was immersed in a 1 % HNO_3
112 solution for 1 day with continuous shaking (50 rpm) to wash away these copper
113 nanoparticles. These etched membranes are denoted as TFC-Cu50X, TFC-Cu100X
114 and TFC-Cu200X, respectively. In addition, we further examined the effect of

115 concentration of the HNO_3 solution on membrane structure and separation
116 performance. Specifically, different concentration HNO_3 solution (i.e., 0.01, 0.1 and
117 1 %) was used to etch the TFC-Cu100 membrane, and the etched membranes are
118 denoted as TFC-Cu100X0.01, TFC-Cu100X0.1, and TFC-Cu100X, respectively.

119



120

121 Fig.1. Fabrication scheme of the novel arch-like TFC membrane containing nanovoids. First,
122 CuNPs were *in situ* generated onto polysulfone surface by the additional of CuSO_4 and NaBH_4 (50,
123 100 and 200 mM) respectively, followed by performing interfacial polymerization reaction
124 between 1% MPD and 0.2% TMC. The resultant CuNPs contained membrane was then etched by
125 1% HNO_3 solution to obtain the final product membrane.

126

127 2.4. Membrane Characterization

128 Membrane surface morphology was examined by scanning electron microscopy
129 (SEM, LEO 1530, UK) and the elemental composition of the membranes were
130 analyzed by energy dispersive spectroscopy (EDS). Before the measurement,
131 membranes samples were dried in air, coating with gold and platinum. SEM
132 characterization was applied at an accelerating voltage of 5 kV, while EDS analysis
133 was conducted at the voltage of 20 kV. Transmission electron microscopy (Philips
134 CM100, TEM) was applied for analyzing the cross-sectional membrane morphology
135 based on our previous method [23]. Substrate pore size and CuNPs size distribution
136 were analyzed by image software (Image-Pro Plus, MediaCybernetics, Inc).

137

138 Attenuated total reflection Fourier transform infrared (ATR-FTIR, Nicolet 6700)
139 spectroscopy was used to assess membrane functional groups over a wave number
140 range from 650 to 4000 cm^{-1} at a resolution of 2 cm^{-1} . The roughness of membrane
141 surface was determined by atomic force microscopy (AFM, Multimode 8, Bruker,
142 MA) with a scanning size of $5 \times 5 \mu\text{m}$. The value of root-mean-square roughness
143 (RMS or R_q) was obtained using software Nanoscope Analysis software (Bruker,
144 MA).

145

146 *2.5. Separation performance testing*

147 A cross-flow laboratory filtration setup was used to test membrane water flux and salt
148 rejection [24]. The membrane was first filtrated at an applied pressure of 21 bar for 3
149 hours with 2000 ppm NaCl solution as feed solution. Then, the pressure was set at 20
150 bar for the measurement of water flux. The water flux was determined based on the
151 volume of permeate water collected over a specified time interval (Equation (1)).
152 Membrane salt rejection (R) was calculated based on the measured conductivity of the
153 feed solution and permeates water (Equation (2)) using an electric conductivity meter
154 (Ultrameter II TM, model 4P, Myron Company, Carlsbad, CA).

$$155 \quad J_w = \frac{\Delta V}{\Delta t \times A} \quad (1)$$

156 where J_w ($\text{Lm}^{-2}\text{h}^{-1}$) is the water flux, Δt (h) is the testing time, A (m^2) is the membrane
157 area, ΔV (L) is the volume of permeate.

158

159
$$R = \left(1 - \frac{C_p}{C_f}\right) \times 100\% \quad (2)$$

160 where C_p is the conductivity of permeate and C_f is the conductivity of the original feed
161 solution.

162

163 According to the solution-diffusion model [25], water permeability and salt
164 permeability are calculated by Equation (3) and (4), respectively.

165

166
$$A = \frac{J_w}{\Delta P - \Delta \pi} \quad (3)$$

167
$$B = \frac{1-R}{R} J_w \quad (4)$$

168

169 where A ($\text{Lm}^{-2}\text{h}^{-1}\text{bar}^{-1}$) is the membrane water permeability constant, B ($\text{Lm}^{-2}\text{h}^{-1}$) is
170 the membrane salt permeability constant, ΔP is the applied pressure and $\Delta \pi$ is the
171 osmotic pressure difference between feed and permeate solution.

172

173 *2.6. Quantifying of copper loading*

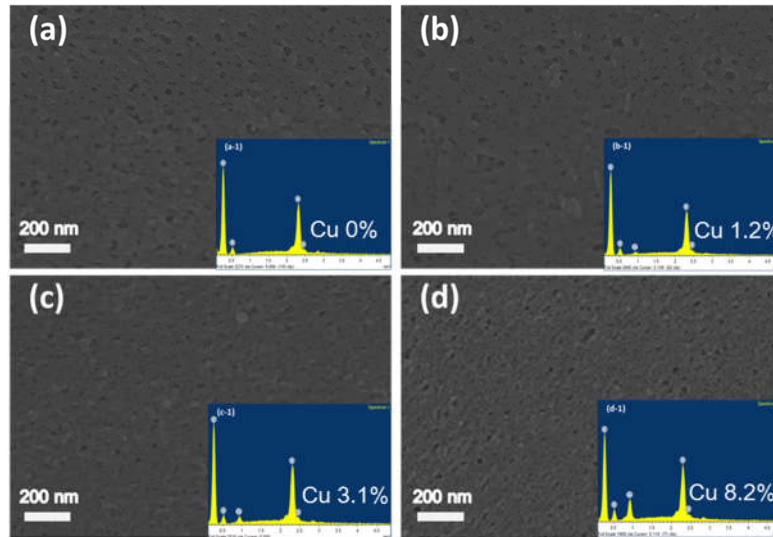
174 To measure the total amounts of copper in membrane samples, CuNPs incorporated
175 membrane coupons (Membrane area=0.95 cm^2) was immersed in a strong acidic
176 solution (0.2 ml 69% HNO_3 in 20 ml DI water) under 100 rpm for 3 days. The
177 dissolved copper concentrations in the acidic leaching solutions were quantified by an
178 inductive coupled plasma optical emission spectrometer (ICP-OES, Optima 8×00,
179 PerkinElmer).

180 **3. Results and discussion**

181 *3.1. Membrane characterization*

182 Fig. 2 presents the SEM micrographs (plan view) of the control (PSF) and
183 $\text{CuSO}_4/\text{NaBH}_4$ modified polysulfone (PSF-Cu) substrates. The control polysulfone
184 substrate had a relatively flat surface with a root-mean-square (R_q) roughness of $9.3 \pm$
185 1.8 nm. With the increased concentration of the applied CuSO_4 and NaBH_4 solution,
186 the surface roughness of the modified substrate increased up to 14.9 ± 3.4 nm
187 (Supplementary material, Fig. A1). Elemental analysis of EDS (inserts of Fig. 2)
188 further confirmed that the increased amounts of copper were generated on substrates.
189 The increased roughness and the copper loading may be due to the formation of
190 copper nanoparticles (CuNPs). Ben-Sasson and co-workers reported that the redox
191 reaction between CuSO_4 and NaBH_4 led to the formation of uniform CuNPs of a few
192 tens of nanometers. Further analysis suggests that the average size of the *in situ*
193 generated CuNPs is 15.7 ± 4.8 nm (Fig. A4, CuNPs size distribution), which is
194 comparable to that reported in the literature [22]. Substrate pore size significantly
195 decreased from 35.2 ± 12.8 nm for the control PSF substrate to 17.6 ± 4.7 nm for the
196 PSF-Cu200 substrate as a result of CuNPs loading. In addition, the PSF-Cu200
197 substrate showed an increased contact angle of $91.4 \pm 2.3^\circ$ compared to that of the
198 control PSF substrate ($83.3 \pm 1.7^\circ$, Table A1). This shift in contact angle value is
199 consistent with the existing literature reporting a more hydrophobic surface after the
200 *in situ* reaction between NaBH_4 and CuSO_4 [22].

201



202

203 Fig.2. SEM micrographs of (a) control PSF, (b) PSF-Cu50, (c) PSF-Cu100 and (d) PSF-Cu200
 204 substrates. The corresponding EDS spectra and Cu mass loading are shown in the insert of each
 205 micrograph. The scale bar of all SEM micrographs is 200 nm.

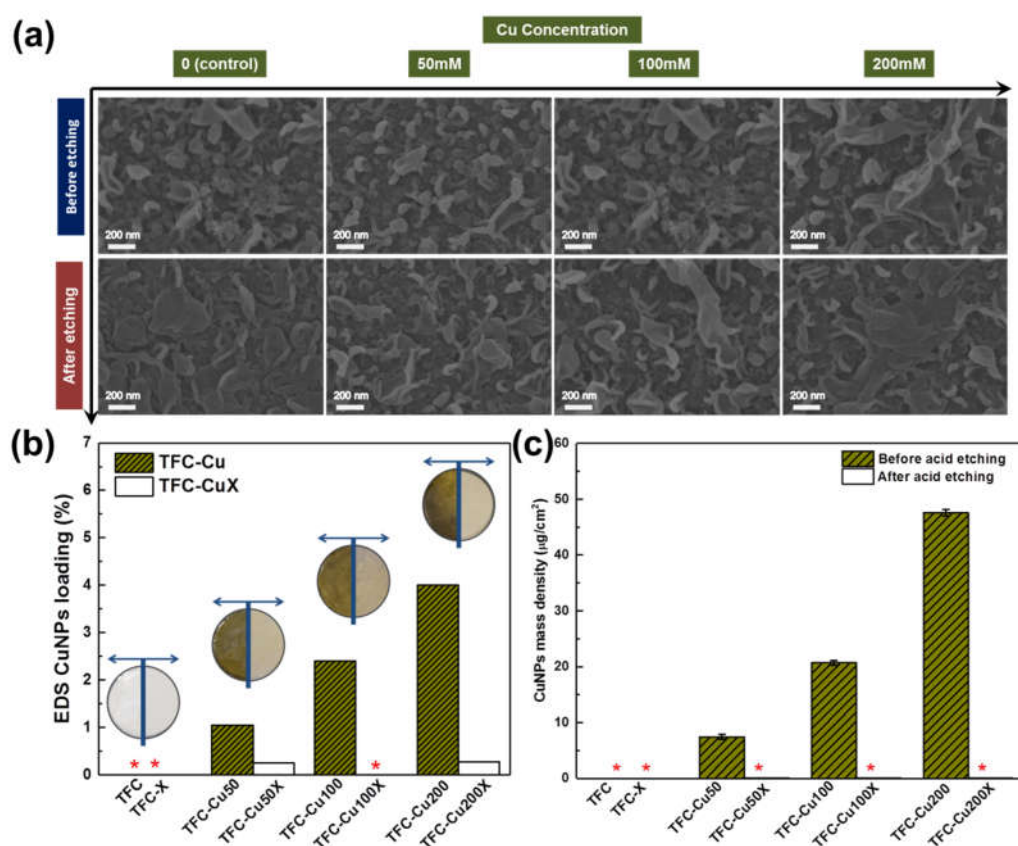
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207 Interfacial polymerization was performed on the PSF and PSF-Cu substrates to
 208 prepare the control membrane (TFC) and the copper loaded polyamide membranes
 209 (TFC-Cu), respectively. These TFC-Cu membranes were subsequently treated by 1%
 210 HNO₃ solution to etch away the CuNPs in the polyamide membranes (TFC-CuX). Fig.
 211 3a and B2 show the surface morphology of these membranes. The control TFC and all
 212 TFC-Cu membranes exhibited ridge-and-valley roughness features that are commonly
 213 observed for the MPD/TMC interfacial chemistry [26]. Even though CuNPs cannot be
 214 directly observed noting that they were covered by the polyamide layer, EDS analysis
 215 (Fig. 3b) confirmed their presence thanks to the relatively deep sample penetration
 216 depth of several micrometers [27]. Furthermore, the surface roughness of the TFC-Cu
 217 membranes systematically increased from 38.8 ± 8.4 nm of the control TFC to $58.4 \pm$
 218 2.6 nm of TFC-Cu200 membrane (Supplementary material, Fig. A2), potentially due

219 to the embedded CuNPs underneath the polyamide layer [24, 28]. Compared to
 220 TFC-Cu membranes, the membranes etched by 1% HNO₃ (TFC-CuX) showed no
 221 significant changes in the surface morphology (Fig. 3a) and FTIR spectra
 222 (Supplementary material, Fig. B1). Nevertheless, the characteristic dark color of the
 223 CuNPs loaded membranes disappeared after the acid treatment (inserts of Fig. 3b).
 224 Both EDX (Fig. 3b) and ICP results (Fig. 3c) show that the residual amount of copper
 225 in the TFC-CuX membranes were negligible, confirming the successful removal of
 226 CuNPs by the 1% HNO₃ treatment.

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228



229

230 Fig. 3. Characterization of TFC, TFC-Cu, and TFC-CuX membranes. (a) SEM micrographs. The

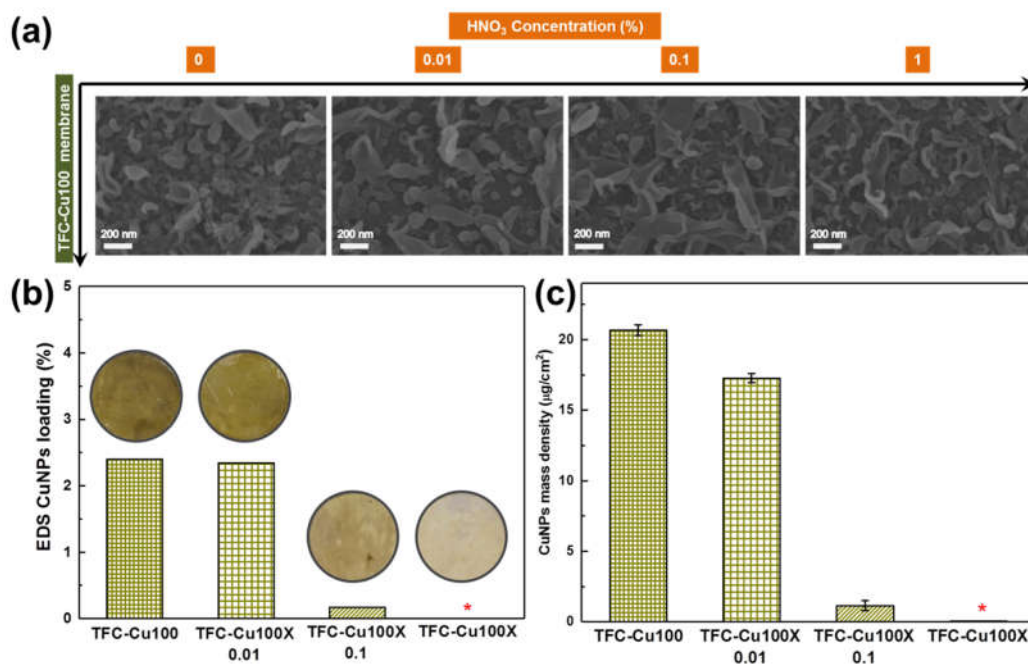
231 Upper panel shows the control TFC and the CuNPs embedded TFC membranes (TFC-Cu50,
232 TFC-Cu100 and TFC-Cu200), while the lower panel shows the corresponding HNO₃ solution
233 etched membranes (TFC-X, TFC-Cu50X, TFC-Cu100X and TFC-Cu200X membranes). The scale
234 bar for all SEM micrographs is 200 nm. (b) CuNPs mass loading analyzed by EDS and the digital
235 photos of the membranes before (left-hand side) and after (right-hand side) HNO₃ etching. (c) ICP
236 CuNPs mass density results of all membranes. Symbol * stands for below detection limit.

237

238

239 We further analyzed the effect of HNO₃ solution concentration on the degree of
240 etching using TFC-Cu100 membranes. Whereas the etched TFC-Cu100X membranes
241 exhibited similar morphologies (Fig. 4a), their color became progressively lighter
242 (inserts of Fig. 4b) as the concentration of HNO₃ significantly increased from 0.01 to
243 1%. This reveals the process from partial to fully etching of the CuNPs at higher
244 HNO₃ concentration, which is further confirmed by the mass loading (EDS analysis,
245 Fig. 4b) and density (ICP results, Fig. 4c) of copper. Notably, when the concentration
246 of HNO₃ increased to 1 wt. %, the CuNPs mass loading of the TFC-Cu100 membrane
247 was below the detection limit, indicating the complete removal of CuNPs.

248



249

250 Fig. 4. Effect of HNO₃ concentration on copper etching. (a) SEM micrographs of TFC-Cu100
 251 membrane treated by different concentration of the HNO₃ solution (0.01, 0.1 and 1 wt. %). Effect
 252 of HNO₃ concentration on copper etching. (b) EDS analysis of CuNPs mass loading and the
 253 digital photos of the TFC-Cu100 and TFC-Cu100X membranes. (c) ICP results of CuNPs mass
 254 density results of the TFC-Cu100 and TFC-Cu100X membranes. Symbol * stands for below
 255 detection limit.

256

257 Fig. 5 presents the TEM cross-sectional images of the TFC-Cu100 (without etching)
 258 and the TFC-Cu100X membranes (etched at 0.01, 0.1, and 1% HNO₃, respectively).

259 Compared to the control TFC-Cu100 membrane (Fig. 5a), the TFC-Cu100X
 260 membranes (Fig. 5b-d) showed an increasing number of nanovoids as the

261 concentration of HNO₃ solution increased from 0.01 to 1%. These nanovoids, whose
 262 dimension was on the order of 10 nm (comparable to the size of the CuNPs of 15.7 ±

263 4.8 nm), can be attributed to the removal of the CuNPs in the PA-PSF interface, as

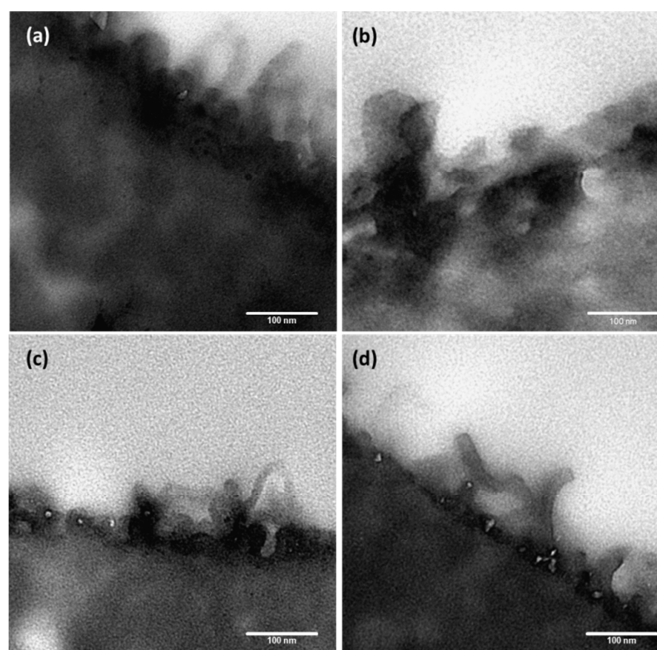
264 confirmed by the EDS and ICP results (Fig. 4b,c). Additional TEM cross-sectional

265 micrographs of TFC-Cu50X and TFC-Cu200X membranes are presents in Fig. B4.

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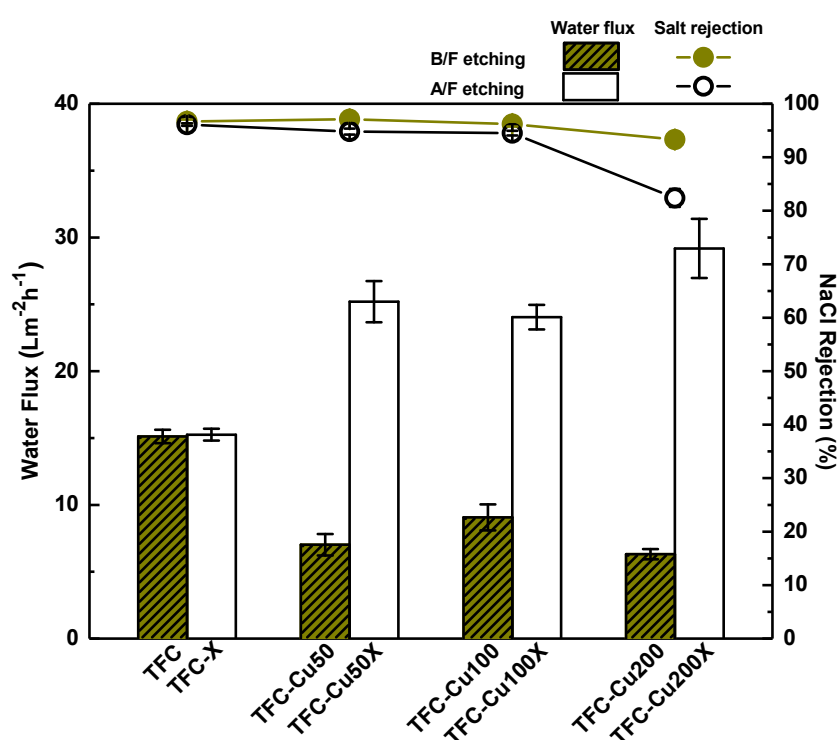
270 Fig. 5 TEM cross-sectional images of the (a) TFC-Cu100 (a) and (b-d) TFC-Cu100X membranes
271 etched at 0.01, 0.1 and 1% HNO₃ solution, respectively. The scale bar for all TEM micrographs is
272 100 nm.

273

274 3.2. Membrane separation performances

275 Fig. 6 presents membrane separation performance of the membranes. The control TFC
276 membrane had a water flux of $15.1 \pm 0.5 \text{ Lm}^{-2}\text{h}^{-1}$ and NaCl rejection of $96.7 \pm 0.3\%$ at
277 an applied pressure of 20 bar (Fig. 6). Acid treatment by 1% HNO₃ had no apparent
278 impact on its separation properties, indicating that the polyamide rejection layer was
279 not compromised in the strong acid [29]. With the incorporation of CuNPs in the
280 polyamide rejection layer, the water fluxes of TFC-Cu membranes were
281 approximately halved compared to that of the control TFC membrane. The increased
282 hydraulic resistances of the TFC-Cu membranes were caused by the presence of the
283 solid CuNPs, which blocks the passage of water molecules. In addition, the decreased

284 surface pore size and hydrophilicity of the CuNPs loaded PSF substrate may also be
 285 partially responsible for the reduced water flux of the corresponding TFC-Cu
 286 membranes [30, 31]. Similar observations have been reported by Zhao et al., [32],
 287 who found that the incorporation of impermeable lipid vesicles in polyamide rejection
 288 layers caused a reduced membrane permeability
 289



290

291 Fig. 6. Membrane separation performance (water flux and salt rejection) of the control TFC-Cu50,
 292 TFC-Cu100, and TFC-Cu200 membranes before and after etching by 1% HNO_3 solution. The
 293 separation performance was evaluated using a feed solution of 2000 ppm NaCl at 20 bar.

294

295

296 After etching, the water flux of the TFC-CuX membrane was significantly improved
 297 compared to that of the corresponding TFC-Cu membrane (Fig. 6). For example, the

298 TFC-Cu50X membrane had a water flux of $25.2 \pm 1.5 \text{ Lm}^{-2}\text{h}^{-1}$, which was nearly 300%

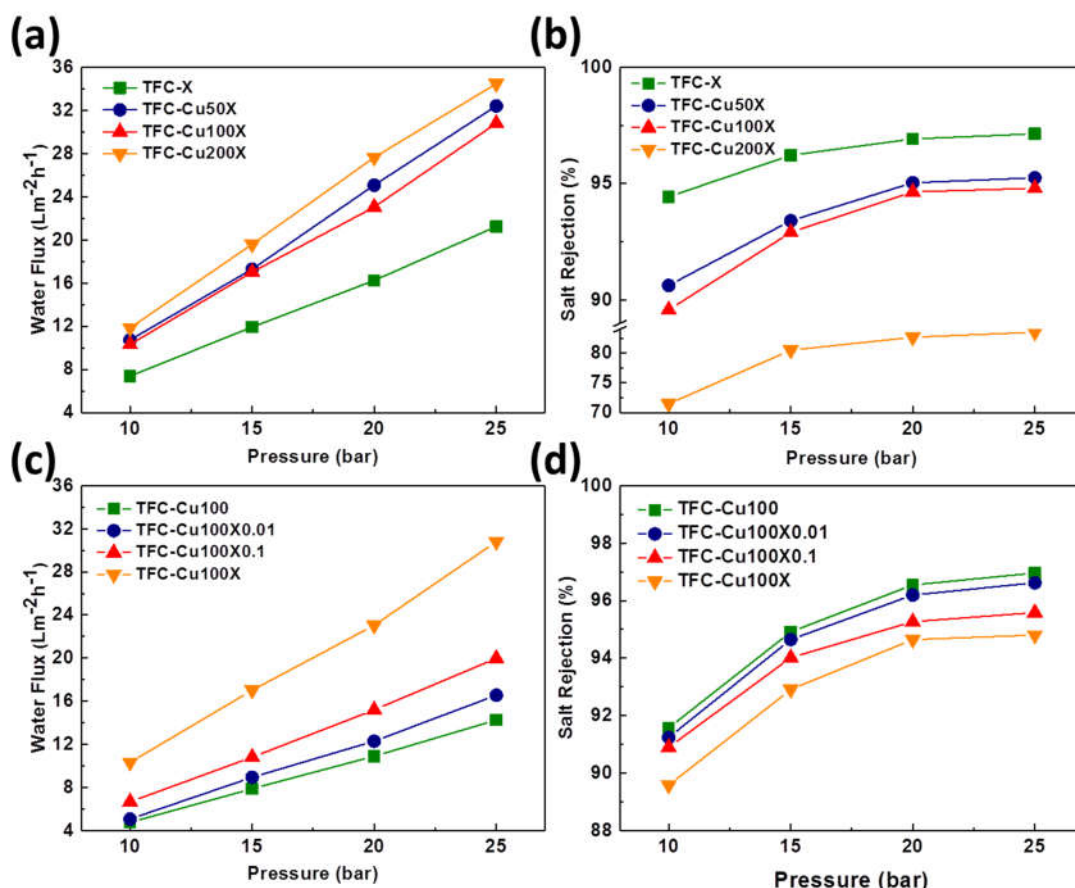
299 higher than that of the TFC-Cu50 membrane of $7.0 \pm 0.8 \text{ Lm}^{-2}\text{h}^{-1}$. The significantly
300 enhanced water flux can be attributed to the creation of additional nanovoids in the
301 dense polyamide layer, thus providing additional shortcuts for water transport.
302 Compared to the control TFC membrane, the TFC-Cu50X membrane achieved a 70%
303 enhancement in water flux while maintaining similar NaCl rejection. Although more
304 permeable membranes can be prepared by loading greater amount of CuNPs followed
305 by their subsequent removal, overloading CuNPs and their subsequent etching can
306 lead to a loss of rejection. In particular, the TFC-Cu200X membrane had a NaCl
307 rejection of only $82.4 \pm 1.7\%$, which was substantially lower than that of the control
308 TFC ($96.7 \pm 0.4\%$). The extensive nanovoids generated in the TFC-Cu200X
309 membrane after HNO_3 etching could have jeopardized the integrity of the polyamide
310 rejection layer.

311

312 The effect of pressure on membrane separation test was conducted by measuring
313 membrane water flux and NaCl rejection over an applied pressure range of 10-25 bar
314 (Fig. 7). The etched membranes (TFC-Cu50X, TFC-100CuX, and TFC-200CuX),
315 even though containing nanovoids in their rejection layer after HNO_3 treatment,
316 showed a linear relationship between water flux and applied pressure, which is
317 consistent with other literature [33, 34]. Furthermore, their NaCl rejection (Fig. 7 b,d)
318 significantly improved as the applied pressure increased. These results are in good
319 agreement with the solution-diffusion theory [25].

320

321



322

323 Fig. 7 Membrane separation tests under different applied pressures (10-25 bar). Water flux and
324 NaCl rejection of all etched membranes of the TFC-X and TFC-Cu50/100/200X membranes (a-b),
325 and the TFC-Cu100 and TFC-Cu100X that were etched by different concentration HNO_3 solution
326 (c-d). All presented data are based on the average value of three parallel membrane samples.

327

328 3.3. Comparison to conventional TFN membranes

329 Table 1 summarizes the recently published TFN membranes in accordance with the
330 nanomaterials incorporated, their loading amounts, and the impact on the separation
331 performance. In general, these TFN membranes were fabricated by incorporating
332 certain amounts of porous nanomaterials (with characteristic pore or channel size on
333 the order of 0.1-10 nm) either in aqueous (MPD) or organic (TMC) phase during the

334 interfacial polymerization reaction. In many cases, the water flux improved (up to
335 200%) as a result of loading these nanoporous materials in the polyamide rejection
336 layer, which was accompanied with either decreased or similar NaCl rejection.
337 Specifically, in some cases, the incorporation of mesoporous silica [7], MWCNTs [9]
338 and GO [35] with relatively large pore size or interlayer spacing (i.e., with
339 characteristic pores size up to several nm), may lead to the loss of NaCl rejection
340 associated with significantly enhanced water flux. This can be potentially due to the
341 deteriorated polyamide integrity or the oversized pores that simultaneously increase
342 both water molecules and solutes transport [1]. On the other hand, when the pore size
343 is relatively small, such as MOFs of 0.6 nm [36] and aquaporin of 0.3 nm [32], their
344 corresponding TFN membranes have similar NaCl rejection with marginally
345 improved water flux compared to that of the control. Notably, one study [37] on
346 aquaporin incorporated TFN membranes showed both enhanced water flux and salt
347 rejection, thanks to the highly permeable and selective channels of aquaporin [38-43].

348

349 In the current study, we synthesized nanovoids-enhanced TFC membranes by etching
350 the CuNPs-based TFN membranes. Compared to the TFN membranes without etching,
351 the nanovoids-enhanced approach offers additional pathways for water transport and
352 thus improves membrane water flux. For example the etched membrane TFC-Cu50X
353 showed approximately 260% higher water flux compared to the membrane TFC-Cu50
354 without etching, revealing the important role of nanovoids in facilitating water

355 transport. This membrane also had a 70% higher water flux compared to that of the
356 control TFC membrane while maintaining similar NaCl rejection. This approach
357 opens new possibilities of preparing high permeability desalination membranes.
358 Though the current CuNPs-based approach is somewhat complicated, this method can
359 be potentially extended to other more soluble nanomaterials, such as MOFs [44, 45],
360 to eliminate the need for the acid etching. The NaCl rejection of the
361 nanovoids-containing TFC membrane is slightly lower than that of the control and
362 TFC-Cu membranes and it is within the traditional flux-rejection trade-off. A
363 comparison of the nanovoids-containing TFC membranes with commercial RO
364 membranes (Table B1) also suggests the need to further enhance their NaCl rejection.
365 Considering the critical role of size effect (Table 1), future studies should consider the
366 optimization of the properties of the nanovoids (e.g., size, number density, etc.) in
367 addition to the further tuning of reaction conditions of interfacial polymerization [3].

Table 1. Comparison of recent thin-film nanocomposite reverse osmosis membranes to this work.

Nanofiller	Pore size (nm)	Polymer	Optimal loading (%)	Performance	Published year and Reference
Nanovoids	~10	PA ^a	~8 $\mu\text{g}/\text{cm}^2$ CuNPs etched by 1% HNO ₃	Pw \uparrow by 70% with slightly \downarrow NaCl rejection compared to TFC Pw \uparrow by 260% with slightly \downarrow NaCl rejection compared to TFC-Cu	This work
Zeolite	~0.4	PA	0.4% (w/v) in organic phase	Pw \uparrow by 81% with slightly \downarrow NaCl rejection	2007 [4]
Zeolite	~0.4	PA	0.2% (w/v) in organic phase	Pw \uparrow by 47% with slightly \downarrow NaCl rejection	2009 [5]
Mesoporous silica	~3	PA	0.05 (w/v) in organic phase	Pw \uparrow by 64%; No change in NaCl rejection	2012 [6]
Mesoporous silica	~2.5	PA	0.1 (w/v) in organic phase	P _w \uparrow by 180% with slightly \downarrow NaCl rejection	2013 [7]
Micro/Mesoporous silica	~1.8/~2.5	PA	0.05 (w/v) in organic phase	P _w \uparrow by 41%; No change in NaCl rejection	2016 [46]
Proteoliposome with aquaporin	~0.3	PA	10 mgmL ⁻¹ in aqueous phase	P _w \uparrow by 25%; No change in NaCl rejection	2012 [32]
Proteoliposome with aquaporin	~0.3	PA	Not available	P _w \uparrow by 90%; \uparrow NaCl rejection	2016 [37]
MOFs ^b	~3.4	PA	0.2 (w/v) in organic phase	Flux \uparrow by 130% with similar solvent rejection	2013 [8]
MOFs	~0.6	PA	0.1 (w/v) in organic phase	P _w \uparrow by 52%; No change in NaCl rejection	2017 [36]
MWCNTs ^c	~5	PA	0.1 (w/v) in aqueous phase	P _w \uparrow by 80% with $\downarrow\downarrow$ NaCl rejection	2014 [9]
MWCNTs-NH ₂	~5-20	PA	0.003 (w/v) in aqueous phase	Pw \uparrow by 38%; No change in NaCl rejection	2017 [47]
GO ^d	-	PA	~40 ppm in aqueous phase	Pw \uparrow by 84%; No change in NaCl rejection	2015 [48]
GO	0.83 interlayer space	PA	0.02% (w/v) in organic phase	Pw \uparrow by 52% with slightly \downarrow NaCl rejection	2016 [35]

369

Note:

370

^aPA: polyamide

371

^bMOFs: metal-organic frameworks

372

^cMWCNTs: Multi-walled carbon nanotubes

373

^dGO: graphene oxide

374

Adapted from Ref. [24]

375

376 *3.4. Conclusions*

377 In this study, novel nanovoids-enhanced TFC membranes were fabricated by etching
378 CuNPs incorporated in the PA-PSF interface using a strong acid. The resulting etched
379 TFC-CuX membranes showed significantly improved water permeability compared to
380 both the control TFC membrane and the corresponding CuNPs containing counterpart.
381 Our study clearly demonstrates the feasibility of using sacrificial CuNPs in creating
382 nanovoids as well as their critical role in enhancing water transport through the
383 polyamide rejection layer. Future study may further explore the impact of the
384 nanovoids sizes and density on membrane separation performance as well as
385 alternative candidates of removable nanomaterials.

386

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390

391 **Appendices**

392 Appendix A. AFM, ATR-FTIR and contact angle results of all substrates and CuNPs
393 size distribution; Appendix B. ATR-FTIR, additional SEM and TEM, separation
394 performance, a table of comparison of commercial membranes to this work.

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